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## **U.S. PATENT DOCUMENTS**

| *. |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Name              | Classification |
|----|---|--|-----------------|-------------------|----------------|
| *  | Α | US-6,639,212                                     | 10-2003         | Guevremont et al. | 250/282        |
| *  | В | US-2003/0157269                                  | 08-2003         | Ratner et al.     | 427/535        |
| *  | С | US-5,066,512                                     | 11-1991         | Goldowsky et al.  | 427/466        |
| *  | D | US-6,696,105                                     | 02-2004         | Hiroki et al.     | 427/466        |
|    | E | US-  |                 |                   |                |
| •  | F | US-  |                 |                   |                |
|    | G | US-  |                 |                   | •              |
|    | Н | US-  |                 | *                 |                |
|    | ı | US-  |                 |                   |                |
|    | J | US-  |                 |                   |                |
|    | K | US   |                 |                   |                |
|    | L | US-  |                 |                   |                |
|    | М | US-  |                 |                   |                |

## FOREIGN PATENT DOCUMENTS

| * |   | Document Number<br>Country Code-Number-Kind Code | Date<br>MM-YYYY | Country | Name           | Classification |
|---|---|--|-----------------|---------|----------------|----------------|
| * | N | JP 2001353454                                    | 12-2007         | Japan   | Tomoyuki et al |                |
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|   | R |  |                 |         |                |                |
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## **NON-PATENT DOCUMENTS**

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|---|----------|---|
| * |          | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
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